



### N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = 25°C
	12mΩ @ V <sub>GS</sub> = 10V	10A
30V	16mΩ @ V <sub>GS</sub> = 4.5V	8.5A

## **Features and Benefits**

- 0.6mm profile Ideal for Low Profile Applications
- PCB Footprint of 4mm<sup>2</sup>
- Low Gate Threshold Voltage
- Low On-Resistance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN3016LFDFQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

## **Description and Applications**

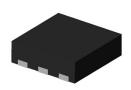
This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and ideal for use in:

- Battery Management Applications
- Power Management Functions
- DC-DC Converters

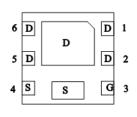
### **Mechanical Data**

- Case: U-DFN2020-6 (Type F)
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0065 grams (Approximate)

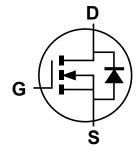
U-DFN2020-6 (Type F)







Pinout Bottom View



Equivalent Circuit

### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3016LFDFQ-7	U-DFN2020-6 (Type F)	3000/Tape & Reel
DMN3016LFDFQ-13	U-DFN2020-6 (Type F)	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3).compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



# **Marking Information**

Site 1



NZ = Product Type Marking Code YM = Date Code Marking Y = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Kev

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	ı	J	K	L	М	N	0	Р	R	S	Т	U
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2



NZ = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 1 = 2021) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

Year	2019	2020	2021	2022	2023	2024	2025	2026
Code	9	0	1	2	3	4	5	6
Week		1-26			27-52		53	
Code		A-Z			a-z		z	
Internal Code	Sun	Mon	1	ue	Wed	Thu	Fri	Sat
Code	Т	U		V	W	Х	Y	Z



## **Maximum Ratings** (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	$V_{DSS}$	30	V		
Gate-Source Voltage			$V_{GSS}$	±20	V
Continuous Drain Current (Note 6) V = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	10 8	Α
Continuous Drain Current (Note 6) $V_{GS} = 10V$ $t<10s$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$			I <sub>D</sub>	12 9	А
Maximum Continuous Body Diode Forward Currer	nt (Note 5)		Is	2.5	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)				Α
Avalanche Current (Note 7) L = 0.1mH		I <sub>AR</sub>	22	А	
Avalanche Energy (Note 7) L = 0.1mH			E <sub>AR</sub>	24	mJ

# Thermal Characteristics (@ $T_A = \pm 25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	0	0.73	W	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +70°C	$P_D$	0.47	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	0	174	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	121		
Total Dawar Dissination (Note 6)		Б	2.02	W	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	$P_{D}$	1.30	VV	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	0	66		
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	42	°C/W	
Thermal Resistance, Junction to Case (Note 6)	Steady State	$R_{ heta JC}$	11.6		
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C	

## Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

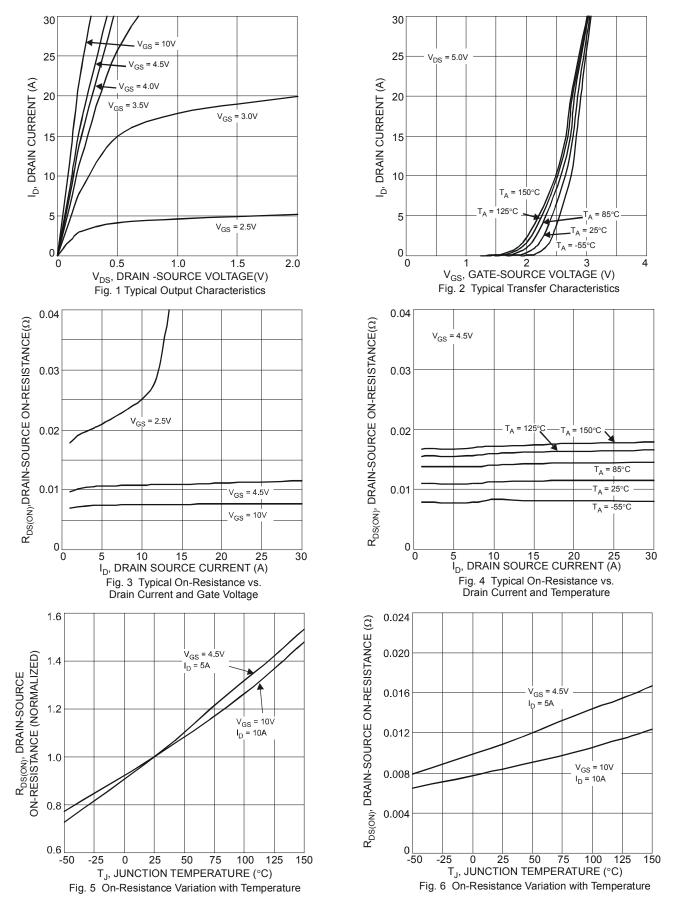
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)				•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)						•	
Gate Threshold Voltage	$V_{GS(TH)}$	1.4	_	2.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	8	12	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 11A	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	12	16	11177	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 9A	
Diode Forward Voltage	V <sub>SD</sub>	_	0.70	1.0	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	_	1415	_		151/11/ 01/	
Output Capacitance	C <sub>oss</sub>	_	119	_	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	82	_		I = 1.0IVIH2	
Gate Resistance	Rg	_	2.6	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qq	_	11.3	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	25.1	_	nC	15)/ 15)/ 1 100	
Gate-Source Charge	Qgs	_	3.5	_	IIC	$V_{DS} = 15V, I_D = 12A$	
Gate-Drain Charge	$Q_{qd}$	_	3.6	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.8	_			
Turn-On Rise Time	t <sub>R</sub>	_	16.5	_		$V_{DD} = 15V, V_{GS} = 10V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	26.1	_	ns	$R_L = 1.25\Omega$ , $R_q = 3\Omega$	
Turn-Off Fall Time	t <sub>F</sub>	_	5.6	_			
Reverse Recovery Time	t <sub>RR</sub>	_	12.3	_	ns		
Reverse Recovery Charge	Opp	_	10.4	_	nC	I <sub>F</sub> = 12A, di/dt = 500A/μs	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

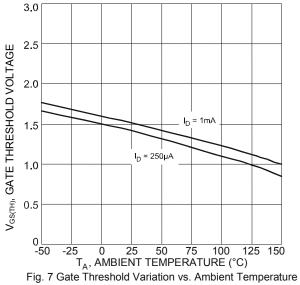
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
7. I<sub>AS</sub> and E<sub>AS</sub> rating are based on low frequency and duty cycles to keep T<sub>J</sub> = +25°C.
8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.

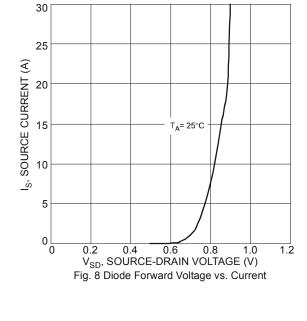


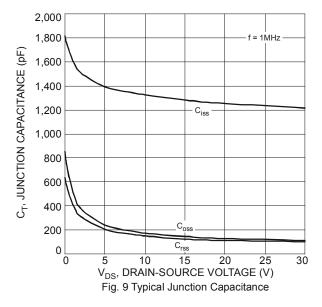


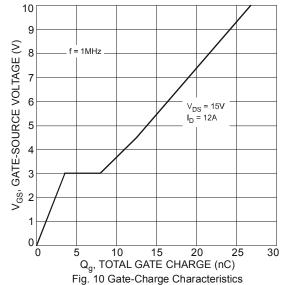














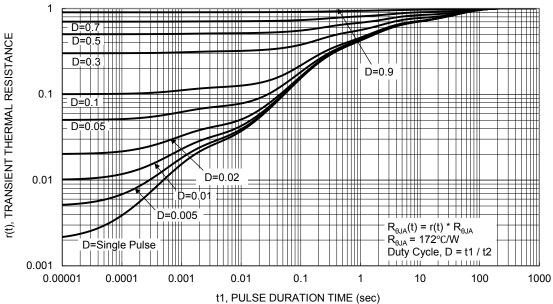


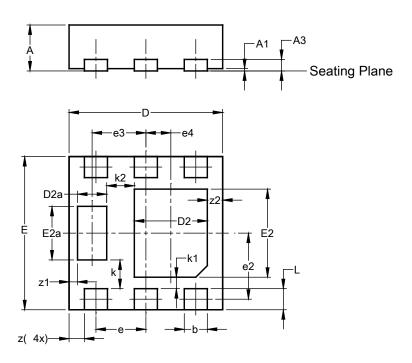
Figure 11. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### U-DFN2020-6 (Type F)

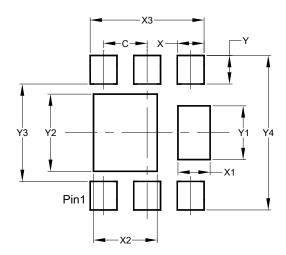


U-DFN2020-6								
(Type F)								
Dim	Min Max Typ							
Α	0.57	0.63	0.60					
A1	0.00	0.05	0.03					
A3	-	-	0.15					
b	0.25	0.35	0.30					
D	1.95	2.05	2.00					
D2	0.85	1.05	0.95					
D2a	0.33	0.43	0.38					
Е	1.95	2.05	2.00					
E2	1.05	1.25	1.15					
E2a	0.65	0.75	0.70					
е		0.65 BS	С					
e2	(	).863 BS	SC					
е3		0.70 BS	С					
e4	(	).325 BS	SC					
k		0.37 BS	С					
k1	0.15 BSC							
k2	0.36 BSC							
L	0.225	0.325	0.275					
Z		0.20 BS	C					
z1		).110 BS	SC					
z2		0.20 BS	C					
All C	)imens	ions in	mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### U-DFN2020-6 (Type F)



Dimensions	Value
Dillielisions	(in mm)
С	0.650
X	0.400
X1	0.480
X2	0.950
Х3	1.700
Y	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300



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